

HCS65R380S

650V N-Channel Super Junction MOSFET

Features

- Very Low FOM ($R_{DS(on)} \times Q_g$)
- Extremely low switching loss
- Excellent stability and uniformity
- 100% Avalanche Tested
- Built-in ESD Diode


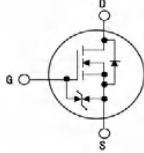
Application

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- TV power & LED Lighting Power
- AC to DC Converters
- Telecom

Key Parameters

| Parameter | Value | Unit |
|------------------------|-------|----------|
| $BV_{DSS} @ T_{j,max}$ | 700 | V |
| I_D | 10.4 | A |
| $R_{DS(on), max}$ | 0.38 | Ω |
| Q_g, Typ | 22.6 | nC |

Package & Internal Circuit

| TO-220FS | SYMBOL |
|---|---|
|  |  |

Absolute Maximum Ratings $T_C=25^\circ\text{C}$ unless otherwise specified

| Symbol | Parameter | Value | Unit |
|----------------|---|-------------|------------------|
| V_{DSS} | Drain-Source Voltage | 650 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| I_D | Drain Current - Continuous ($T_C = 25^\circ\text{C}$) | 10.4 * | A |
| | Drain Current - Continuous ($T_C = 100^\circ\text{C}$) | 6.6 * | A |
| $I_{DM}^{1)}$ | Drain Current - Pulsed | 31.0 * | A |
| $E_{AS}^{2)}$ | Single Pulsed Avalanche Energy | 133 | mJ |
| I_{AR} | Avalanche Current | 1.75 | A |
| dv/dt | MOSFET dv/dt ruggedness, $V_{DS}=0 \dots 400\text{V}$ | 50 | V/ns |
| dv/dt | Reverse diode dv/dt, $V_{DS}=0 \dots 400\text{V}$, $I_{DS} \leq I_D$ | 15 | V/ns |
| P_D | Power Dissipation ($T_C = 25^\circ\text{C}$) | 30 | W |
| $V_{ESD(G-S)}$ | Gate source ESD(HBM-C=100pF, R=1.5K Ω) | 2000 | V |
| T_J, T_{STG} | Operating and Storage Temperature Range | -55 to +150 | $^\circ\text{C}$ |

* Drain current limited by maximum junction temperature

Thermal Resistance Characteristics

| Symbol | Parameter | Value | Unit |
|-----------------|---|-------|--------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case, Max. | 4.1 | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient, Max. | 80 | $^\circ\text{C/W}$ |

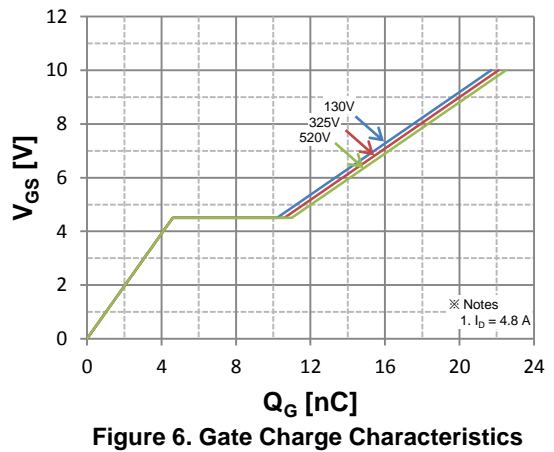
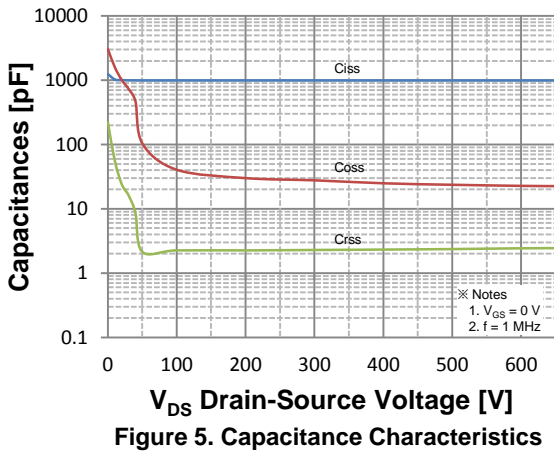
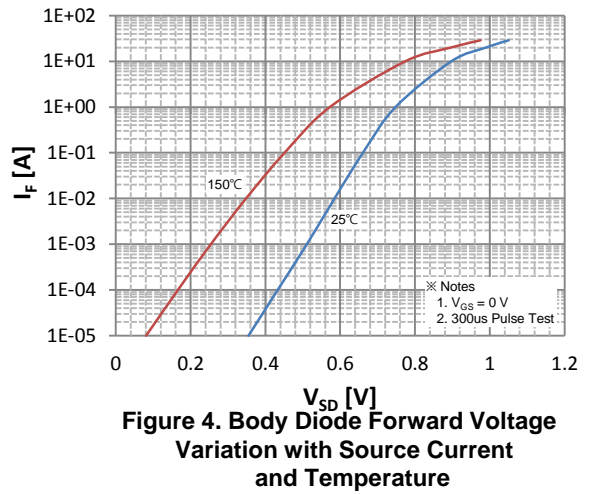
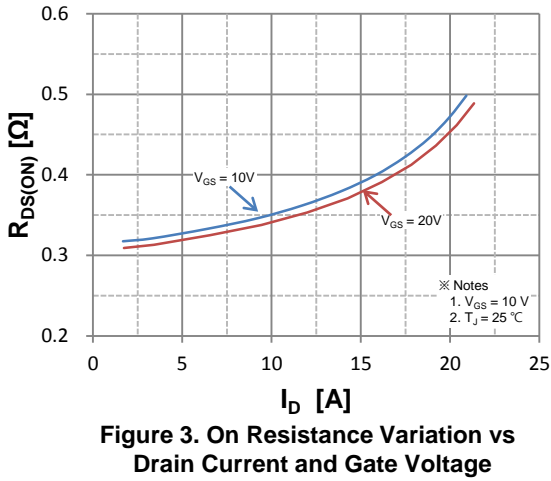
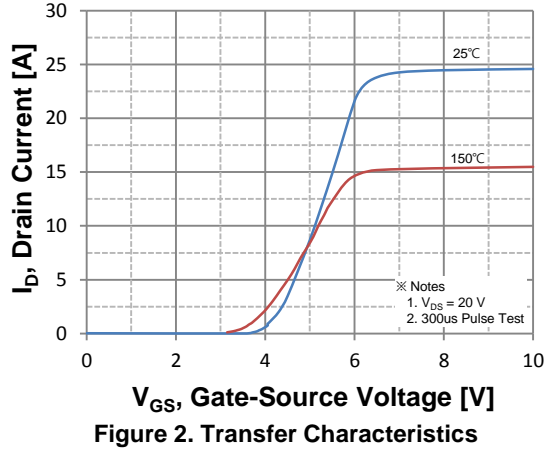
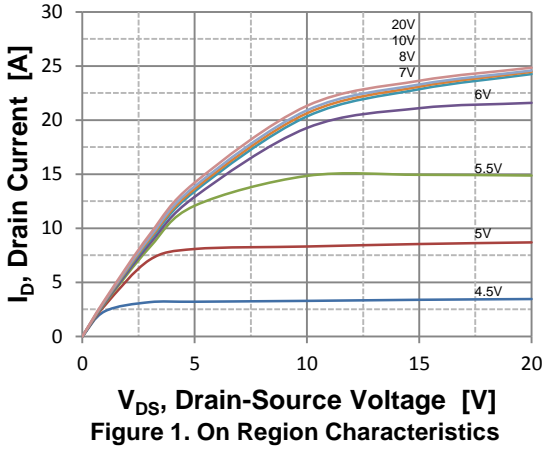
Electrical Characteristics $T_J=25^\circ\text{C}$ unless otherwise specified

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
|---|---|---|-----|------|---------|---------------|
| On Characteristics | | | | | | |
| V_{GS} | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_D = 370 \mu\text{A}$ | 2.0 | - | 4.0 | V |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance | $V_{GS} = 10 \text{ V}, I_D = 3.4 \text{ A}$ | - | 0.33 | 0.38 | Ω |
| Off Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$ | 650 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 650 \text{ V}, V_{GS} = 0$ | - | - | 1 | μA |
| | | $V_{DS} = 650 \text{ V}, T_C = 150^\circ\text{C}$ | - | - | 100 | μA |
| I_{GSS} | Gate-Body Leakage Current | $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ | - | - | ± 1 | μA |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | $V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1.0 \text{ MHz}$ | - | 990 | - | pF |
| C_{oss} | Output Capacitance | | - | 25 | - | pF |
| C_{rss} | Reverse Transfer Capacitance | | - | 2.5 | - | pF |
| Switching Characteristics | | | | | | |
| $t_{d(on)}$ | Turn-On Time | $V_{DS} = 325 \text{ V}, I_D = 4.8 \text{ A},$ $R_G = 25 \Omega$ (Note 3,4) | - | 28 | - | ns |
| t_r | Turn-On Rise Time | | - | 20 | - | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | - | 114 | - | ns |
| t_f | Turn-Off Fall Time | | - | 17 | - | ns |
| Q_{gt} | Total Gate Charge | $V_{DS} = 520 \text{ V}, I_D = 4.8 \text{ A},$ $V_{GS} = 10 \text{ V}$ (Note 3,4) | - | 22.6 | - | nC |
| Q_{gs} | Gate-Source Charge | | - | 4.6 | - | nC |
| Q_{gd} | Gate-Drain Charge | | - | 6.4 | - | nC |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| I_S | Maximum Continuous Drain-Source Diode Forward Current | | - | - | 10.4 | A |
| I_{SM} | Maximum Pulsed Drain-Source Diode Forward Current | | - | - | 31 | A |
| V_{SD} | Drain-Source Diode Forward Voltage | $V_{GS} = 0 \text{ V}, I_S = 4.8 \text{ A}$ | - | - | 1.3 | V |
| t_{rr} | Reverse Recovery Time | $V_R = 400 \text{ V}, I_F = 4.8 \text{ A}$ $di_F/dt = 100 \text{ A}/\mu\text{s}$ | - | 250 | - | ns |
| Q_{rr} | Reverse Recovery Charge | | - | 2.6 | - | μC |

Notes :

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. $I_{AS}=1.75\text{A}, V_{DD}=50\text{V}, R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$
3. Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$
4. Essentially Independent of Operating Temperature

Typical Characteristics



Typical Characteristics (continued)

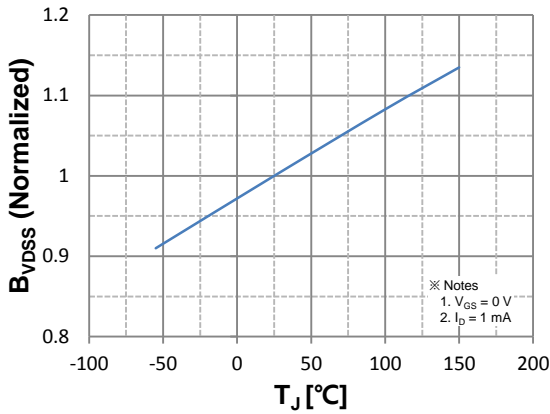


Figure 7. Breakdown Voltage Variation vs. Temperature

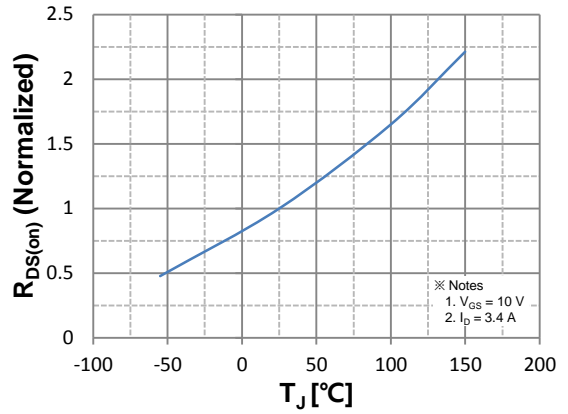


Figure 8. On-Resistance Variation vs. Temperature

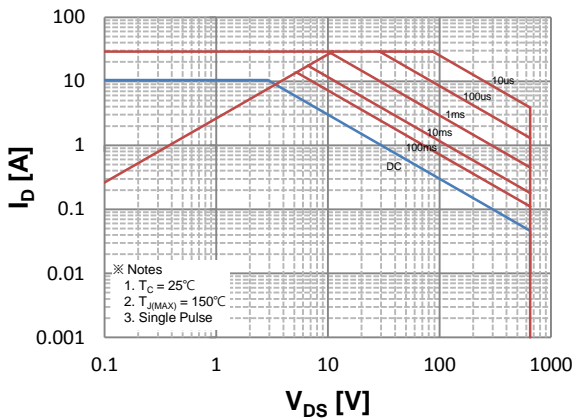


Figure 9. Maximum Safe Operating Area

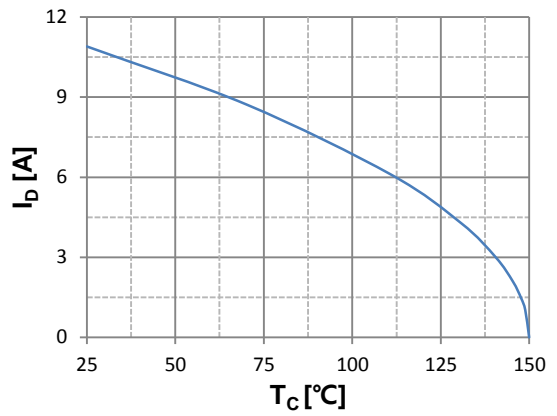


Figure 10. Maximum Drain Current vs. Case Temperature

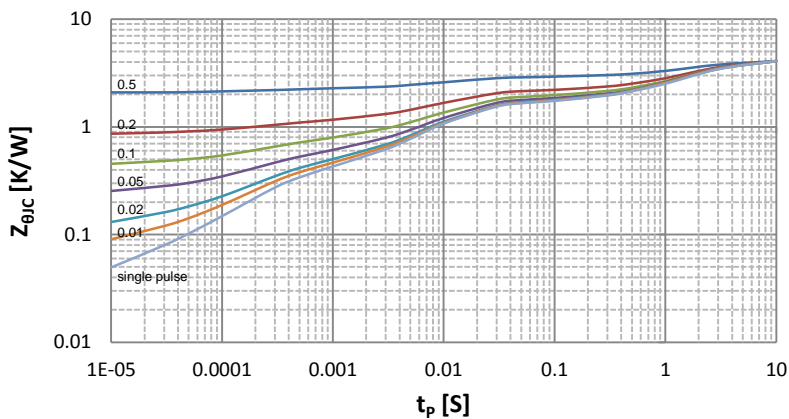


Figure 11. Transient Thermal Response Curve

Fig 12. Gate Charge Test Circuit & Waveform

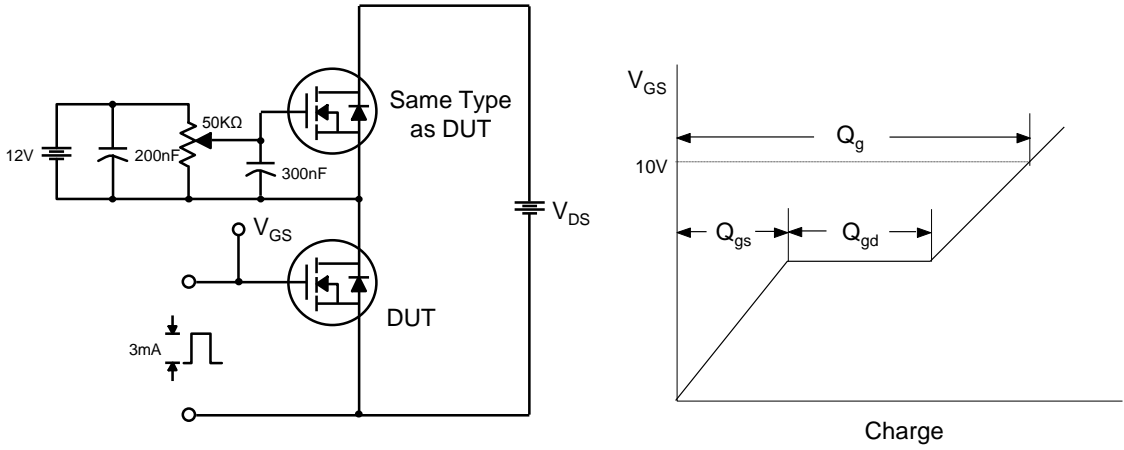


Fig 13. Resistive Switching Test Circuit & Waveforms

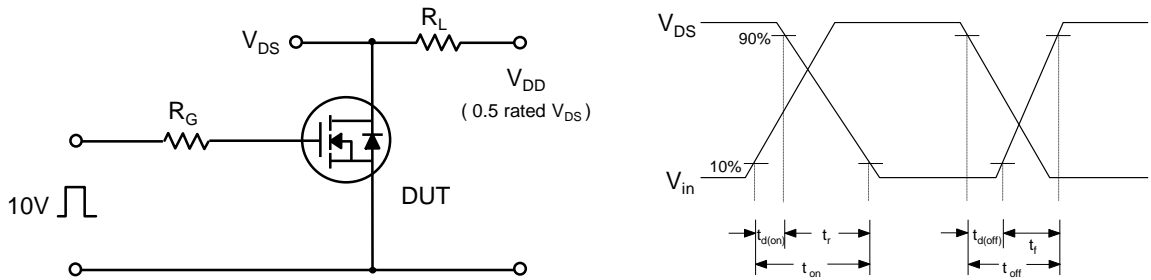


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

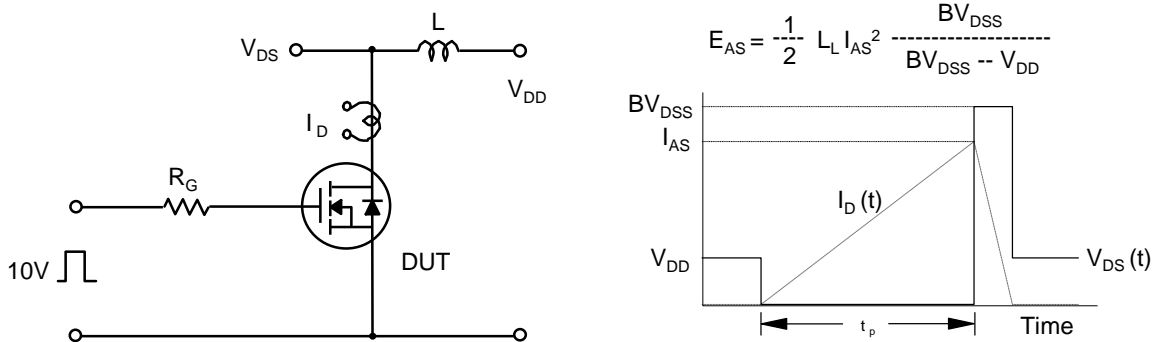
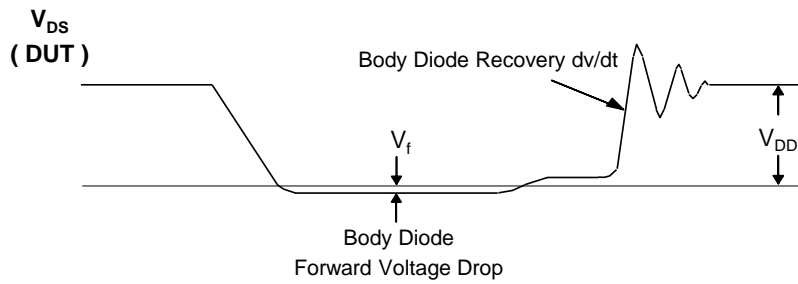
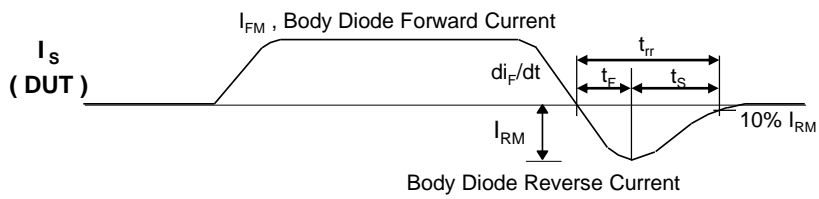
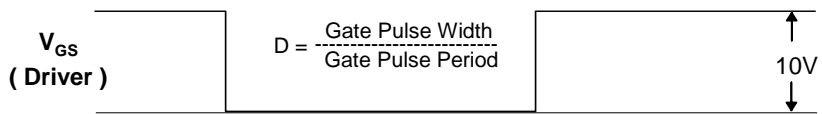
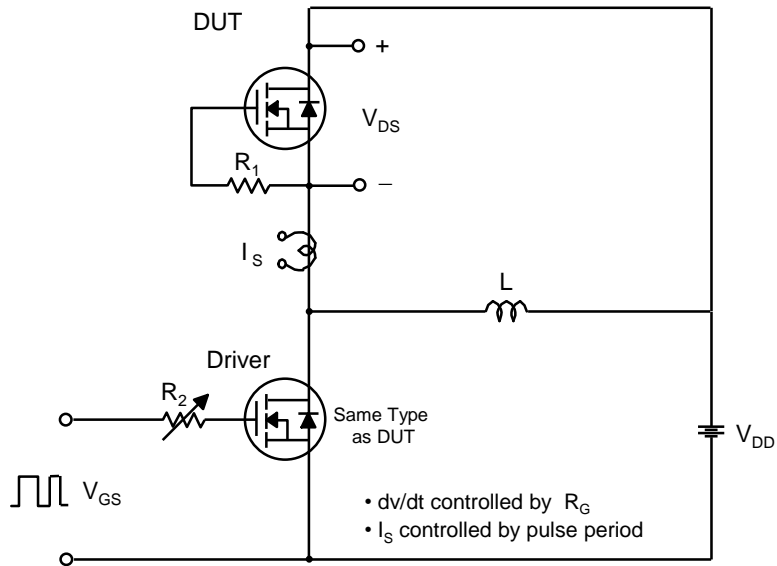


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



Package Dimension

TO-220FS-FM(Full Mold)

